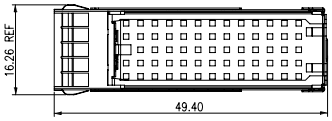
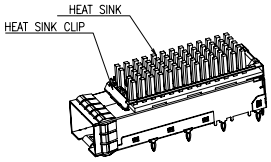
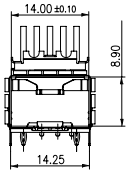
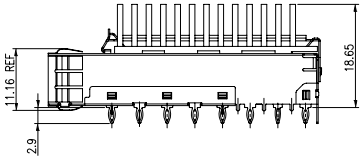
SFP*XFP*QSFP/QSFP+ Connectors

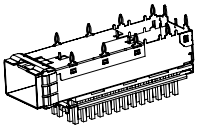
KLS1-SFP+03





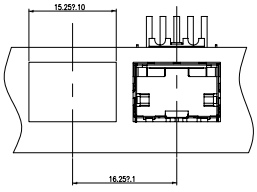


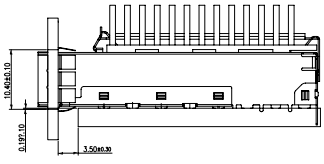


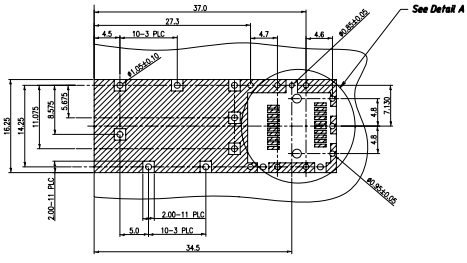


NOTE:

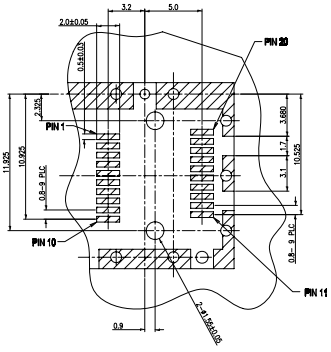
1, DESCRIPTION
   01 SFP CAGE : T=0.25
   02 SFP EMI CLIP: T=0.25 Ni FOR ALL PLATING
   03 SFP HEAT SINK: AL Ni FOR ALL PLATING
   04 SFP HEAT SINK CLIP: SUS 301½H T=0.25mm
2, TEMPERATURE:
   OPERATION: −40°C~+85°C
   STORAGE: −55°C~+105°C







PCB LAYOUT THICKNESS=3.0mm (TOP VIEW)



DETAIL A
SCALE 2:1

ORDER INFORMATION

KLS1-SFP+03

Part Number